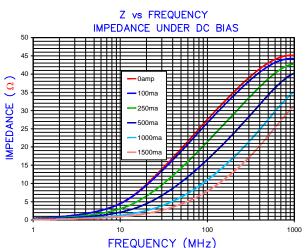
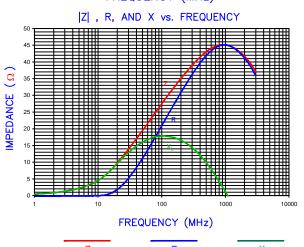
## HI0603R300R-10

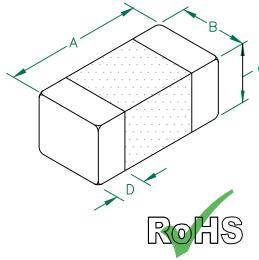
## PHYSICAL DIMENSIONS:

Α	1.60	$\lfloor .063 \rfloor$	<del>-</del> 0.15	[.006]
В	0.80	[.031]	± 0.15	[.006]
С	0.80	[.031]	± 0.15	[.006]
D	0.36	[.014]	± 0.15	[.006]





AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3298

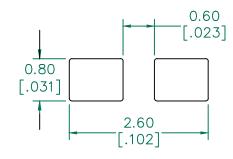


ELECTRICAL CHARACTERISTICS:								
Z @ 100M ( Ω )	1Hz	DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current					
Nominal	30							
Minimum	23							
Maximum	38	0.01	5000 mA					

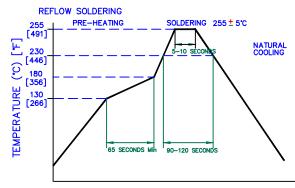
NOTES: UNLESS OTHERWISE SPECIFIED

- TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)
- 5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

## LAND PATTERNS FOR REFLOW SOLDERING



## RECOMMENDED SOLDERING CONDITIONS



(For wave soldering, add 0.762 [.030] to this dimension)

DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird				
				Tech. and is loaned in confidence subject to return upon request an	a 🔳	_ !		.■"
				with the understanding that no	Laird			
				copies shall be made without the	Lanu			
				written consent of Laird Tech. All rights to design or invention are				
				reserved.				
				PROJECT/PART NUMBER:	REV	PART TYPE	:	DRAWN BY:
С	UPDATE LAIRD LOGO AND NOTES 4	08/05/13	Q	HI0603R300R-10	l c	CO-FI	IRF	YUKI
В	ADD OPERATING TEMPERATURE	11/16/12	QU					10111
	ADD DC BIAS AND UPDATE IR-REFLOW	1			CALE: _ SHEET:			
Α	ORIGINAL DRAFT	03/01/11	YUKI	200 #	OL #		- 1	of 1
REV	DESCRIPTION	DATE	INT	* HI0603R300R-10-C		-		